

Product Compliance Declaration

Please see www.molex.com for the most up-to-date information.

Contact Information

Name Molex Product Compliance E-Mail Product.Compliance@molex.com

Part Information

Part Name 5CKT KK 7.92 WFAS W LOCK 509603C

Product Composition

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
5CKT KK 7.92 WFAS W LOCK 509603C	Assembly		100	1.345392
3.96MM KK WAFER W/LOCK 502805	Component		59.4697	0.8001
PA66 NATURAL	Material		59.4697	0.8001
PA66	Substance		56.4962	0.760095
Further Additives, not to declare	Substance	system	2.9735	0.040005
.045SQ WIRE PIN	Assembly		40.5303	0.545292
1.14 SQ WIRE PIN	Component		39.7276	0.534492
Cartridge Brass 70% Unplated	Material		39.7276	0.534492
Copper	Substance	7440-50-8	27.8093	0.374144
Zinc (metal)	Substance	7440-66-6	11.9183	0.160348
Tin Plating	Material		0.4014	0.0054
Tin	Substance	7440-31-5	0.4014	0.0054
Copper Plating	Material		0.4014	0.0054

Form Rev - F

Limitation of this Product Compliance Declaration: This declaration is based on the state of knowledge and belief of Molex as of the date that it is provided. Molex bases its knowledge and belief on information provided by numerous sources, including third parties, and in certain circumstances laboratory test results. Molex has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and substances. Molex represents that to the best of its knowledge that the information provided in this declaration is accurate. Molex's sole liability shall be to either replace the product or refund the purchase price of the product if it does not meet the requirement of this declaration.

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
Copper	Substance	7440-50-8	0.4014	0.0054

ROHS Declaration Information

Regulatory Revision EU 2015/863

Compliance Status Compliant

Contained Substances Exceeding Threshold

None

Exemptions

None

REACH-SVHC Declaration Information

Regulatory Revision D(2020)9139-DC (19 Jan 2021)

Contained Substances Exceeding Threshold

None

GADSL Declaration Information

Regulatory Revision GADSL imported from IMDS

Contained Substances Exceeding Threshold

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
lead	Cartridge Brass 70% (CA260)	*Note	350	Yes
lead		*Note	500	Yes
copper	Cartridge Brass 70% (CA260)	*Note	700,000	Yes
copper	e-plate Cu (electrodeposited Copper Coatings)	*Note	999,625	Yes

^{*}Note: For GADSL substance declarable/prohibited threshold values, please reference http://www.gadsl.org/

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Exemptions

Part Name	Exemption
Cartridge Brass 70% (CA260)	44 Concentration within acceptable GADSL limits
	44 Concentration within acceptable GADSL limits

HFLH Declaration Information

Regulatory Revision IEC 61249-2-21

Contained Substances Exceeding Threshold

None

China ROHS Declaration Information

Part Number	0010634037 5CKT KK 7.92 WFAS W LOCK						
attivamo	509603C						
Part Information	on		Ha	zardous S	Substance	es	
Components		Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
5CKT KK 7.9	2 WFAS W LOCK 509603C	0	0	0	0	0	0
3.96MM KK V	WAFER W/LOCK 502805	0	0	0	0	0	0
.045SQ WIRE	E PIN	0	0	0	0	0	0
1.14 SQ WIR	E PIN	0	0	0	0	0	0

Process Information

Component Plating / Surface Finish	N/A
Termination Base Alloy	N/A
Solder Alloy	N/A
Process Capability	N/A
Maximum Exposure Time (seconds)	N/A
Maximum Process Temperature (C)	N/A

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Maximum Cycles at Reflow Temperature	N/A
J-STD-020 Moisture Sensitivity Level	N/A

Mar 23, 2021